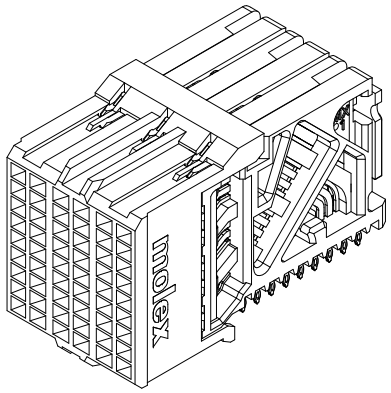
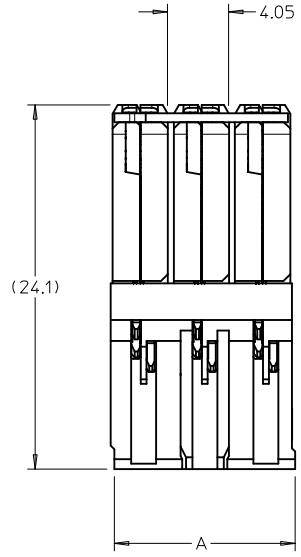
MATERIAL NUMBER	# OF COLUMNS	# OF DIFF PAIR	DIM "A" MAX	DIM "B"	PTHØ
76860-*006	6	18	12.15	10.00	0.46±0.05
76860-*036	6	18	12.15	10.00	0.39±0.05
76860-*008	8	24	16.20	14.05	0.46±0.05
76860-*038	8	24	16.20	14.05	0.39±0.05

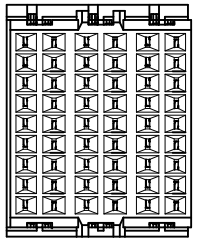
76860-*0**

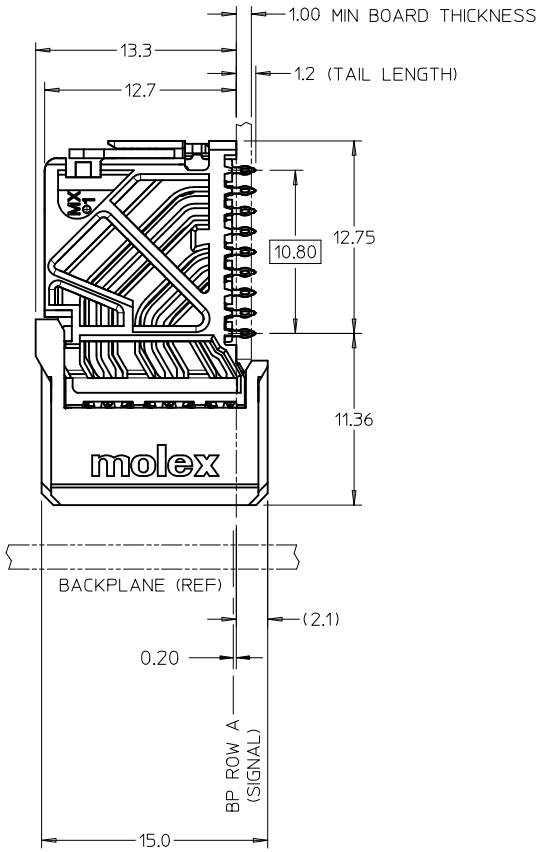
MODULE & TAIL PLATING TYPE
0 = UNGUIDED, TIN-LEAD
1 = UNGUIDED, LEAD-FREE

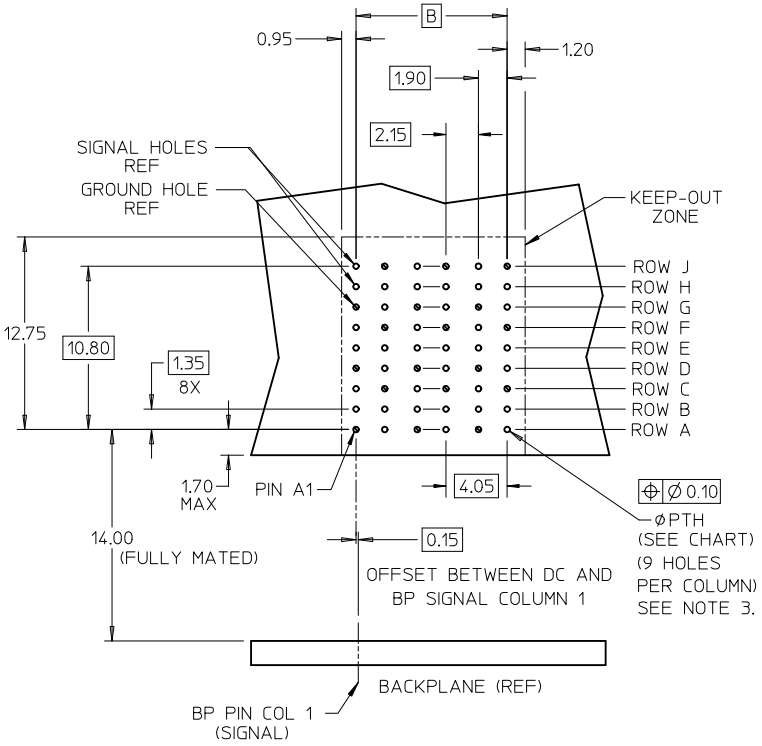
# OF COLUMNS
06 = 6 COL 0.46 PTH
36 = 6 COL 0.39 PTH
08 = 8 COL 0.46 PTH
38 = 8 COL 0.39 PTH











DAUGHTERCARD HOLE PATTERN
(CONNECTOR SIDE)

NOTES:
1. MATERIALS: HOUSING - LIQUID CRYSTAL POLYMER (LCP), GLASS-FILLED, UL94V-0
   TERMINALS - HIGH PERFORMANCE COPPER ALLOY
2. FINISH: 30uIN MIN GOLD IN CONTACT AREA. SELECTIVE TIN OR
   SELECTIVE TIN-LEAD ON PCB TAILS. NICKEL OVERALL.
3. REFER TO MOLEX PRODUCT SPEC PS-76060-999 FOR PERFORMANCE SPECIFICATIONS
   AND ADDITIONAL PCB INFORMATION.
4. EACH SIGNAL WAFER CONTAINS 2 COLUMNS OF TERMINALS.
5. PRODUCT IS PACKAGED PER PK-70873-591.
6. THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPEC PS-45499-002.
7. REFER TO MOLEX SALES DRAWING SD-76855-001 FOR THE MATING HEADERS.
8. REFER TO MOLEX ROUTING GUIDE AS-76850-990 FOR ADDITIONAL PCB LAYOUT
   AND ROUTING RECOMMENDATIONS.

RELEASE FOR PROD
EC NO: UCP2010-0917 2010/01/11
DRWN: JLAURX 2010/01/13
CHKD: TELO 2010/01/14
APPR: JBINGHAM
DESCRIPTION
A
REV

QUALITY SYMBOLS
▼=0
▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± 0.15	± ---
1 PLACE	± 0.25	± ---

ANGULAR ±1/2°

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE: MM ONLY
SCALE: 4:1
DESIGN UNITS: METRIC
THIRD ANGLE PROJECTION

DRAWN BY: JLAURX DATE: 5/5/09
CHECKED BY: TELO DATE: 2010/01/13
APPROVED BY: JBINGHAM DATE: 2010/01/14
MATERIAL NO.: SEE CHART

TITLE: IMPACT DAUGHTERCARD 3 PAIR ORTHOGONAL UNGUIDED SALES DRAWING
molex MOLEX INCORPORATED
DOCUMENT NO.: SD-76860-001
SHEET NO.: 1 OF 1
SIZE: C